

VUTL006R160NA

Datasheet





VUTL006R160NA

General Description

V _{(BR)DSS}	R _{DS(ON)_max}	I_D
60V	16mΩ@10V	55 A
	21mΩ@4.5V	55A

Symbol

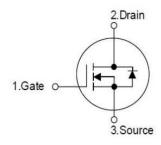


Figure 1 Symbol of VUTL006R160NA

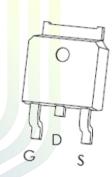
Features

- Trench Technology Power MOSFET
- \blacksquare Low $R_{DS(ON)}$
- Low Gate Charge
- Low Gate Resistance
- 100% UIS Tested

Application

■ Power Switch Application

Package Type



TO-252-2L

Figure 2 Package Type of VUTL006R160NA

Ordering Information

Product Name	Package			
VUTL006R160NA	TO-252-2L			



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Absolute Maximum Ratings (T_A= 25 °C, unless otherwise specified)

Parameter	Symbol	Rating	Unit	
Drain-Source Voltage		V _{DSS}	60	V
Gate-Source Voltage		V _{GSS}	±20	V
Continuous Drain Current ^{Note1}	$T_{\rm C}=25~{\rm ^{\circ}C}$	т	55	
Continuous Drain Current ^{Note1}	$T_{\rm C} = 100 {\rm ^{o}C}$	I_{D}	34	
Pulsed Drain Current Note2		I_{DM}	220	A
Avalanche Current ^{Note3}		I _{AS}	16	
Single Pulsed Avalanche Energy ^{Note3}		Eas	64	mJ
Total Power Dissipation ^{Note5}	$T_{\rm C}=25~{\rm ^{\circ}C}$	P _D	60	W
Junction Temperature		$T_{\rm J}$	150	°C
Storage Temperature		Tstg	-55 to 150	°C

Thermal Resistance

Parameter	Symbol	Min	Typ	Max	Unit
Thermal Resistance, Junction-to-Ambient ^{Note6}	$R_{\theta JA}$		40		°C/W
Thermal Resistance, Junction-to-Case	$R_{ heta JC}$		2.1		°C/W





16mΩ, 60V, N-Channel Power MOSFET

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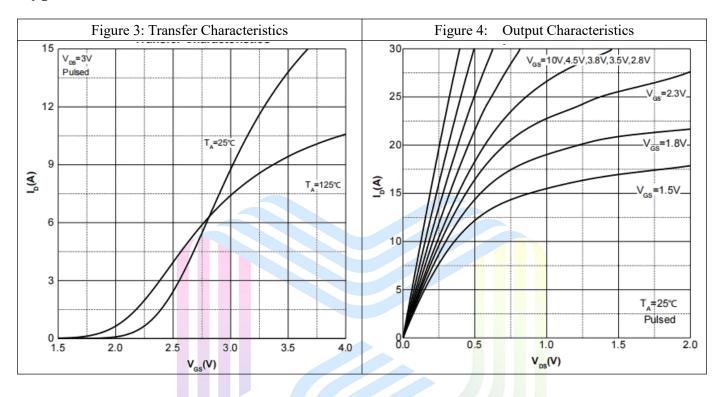
Electrical Characteristics (T_J= 25 °C, unless otherwise specified)

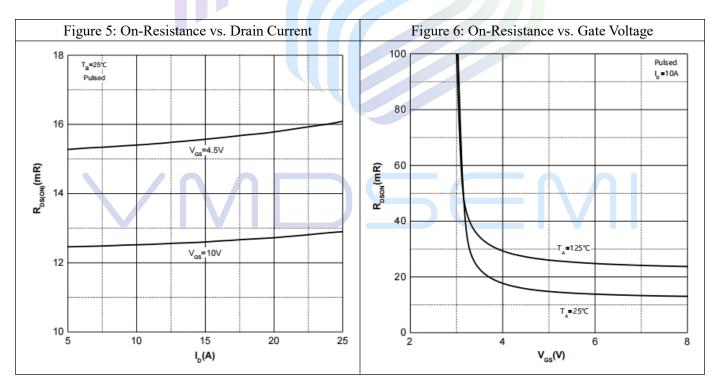
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Statistic Characteristics							
Drain-Source Breakdown Voltage	$\mathrm{BV}_{\mathrm{DSS}}$	$V_{GS}=0V, I_{D}=250uA$	60			V	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 60V, V_{GS} = 0V$			1	uA	
Gate-Body Leakage Current	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA	
Gate Threshold Voltage ^{Note4}	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250uA$	1.0	1.5	3.0	V	
Static Drain-Source On-Resistance ^{Note4}	D	$V_{GS}=10V, I_{D}=20A$	12 16		16		
Static Drain-Source On-Resistance	R _{DS(ON)}	V_{GS} =4.5V, I_{D} = 10A		14	21	mΩ	
Forward Transconductance ^{Note4}	gfs	$V_{DS}=5V, I_{D}=20A$	10	26		S	
Dynamic Characteristics							
Input Capacitance	C _{ISS}	V _{DS} =30V		1764		pF	
Output Capacitance	Coss	V _{GS} =0V		118		pF	
Reverse Transfer Capacitance	C _{RSS}	f=1MHz		107		pF	
Total Gate Charge	Q_{g}	$V_{DS}=30V$		38			
Gate-Source Charge	Q_{gs}	$V_{GS}=10V$		4.2		пC	
Gate-Drain Charge	Q_{gd}	$I_D=20A$		9.5			
Gate Resistance	Rg	f = 1MHz, Open drain		0.9		Ω	
Switching Parameters							
Turn-on Delay Time	t _{d(on)}	$V_{DD}=30V$		9			
Turn-on Rise Time	\mathbf{t}_{r}	$V_{GS}=10V$		5			
Turn-off Delay Time	$t_{ m d(off)}$	$R_L=1.5\Omega$		28		ns	
Turn-off Fall Time	t_{f}	$R_G=3\Omega$		6			
Diode Characteristics							
Diode Forward Voltage Note4	V_{SD}	$V_{GS}=0V, I_{S}=20A$			1.2	V	
Diode Reverse Recovery Time	t _{rr}	$I_F = 20A$, $dI/dt = 500A/ms$		29		ns	
Diode Reverse Recovery Charge	Q _{rr}	$I_F = 20A$, $dI/dt = 500A/ms$		104		пC	

Notes:

- 1. The maximum current rating is limited by package. And device mounted on a large heatsink.
- 2. Pulse Test : Pulse Width $\leq 10\mu s$, duty cycle $\leq 1\%$.
- 3.E_{AS} condition: $V_{DD} = 30V$, $V_{GS} = 10V$, L = 0.5mH, $R_G = 25\Omega$ Starting $T_J = 25$ °C.
- 4. Pulse Test : Pulse Width $\leq 300\mu s$, duty cycle $\leq 2\%$.
- 5. The power dissipation P_D is limited by $T_{J(MAX)} = 150$ °C. And device mounted on a large heatsink
- 6.Device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C.

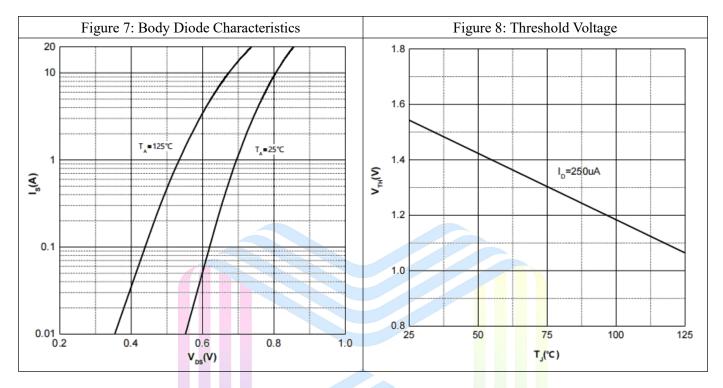
Typical Performance Characteristics

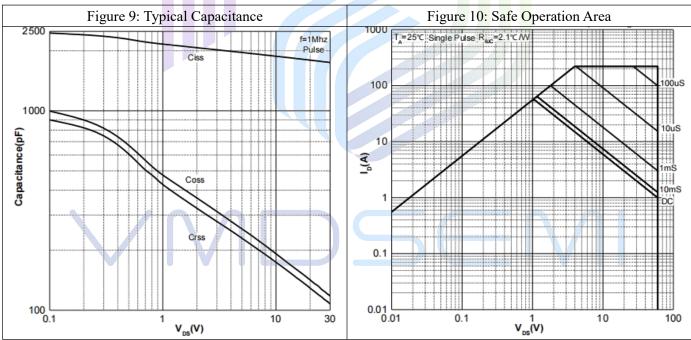






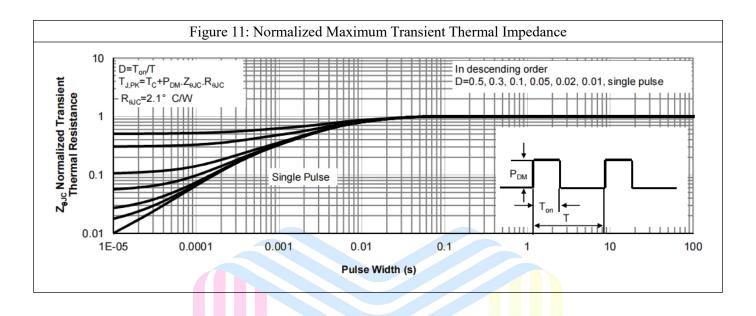
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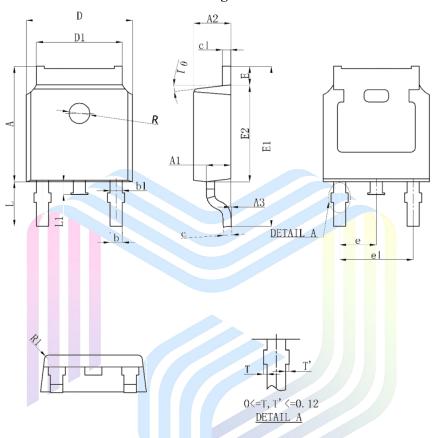






Mechanical Dimensions:

TO-252-2L Package Information



Cumbal	Dimensions In Millimeters		Dimensions In Inches				
Symbol	Mi	n.	Max.	Min.		Max	х.
Α	7.050		7.150	0.278		0.281	
A1	0.9	60	1.060	0.038		0.042	
A2	2.20	00	2.400	0.087		0.094	
A3	0.0	00	0.100	0.000		0.004	
b		0.760	OREF		0.030	REF	
b1		1.000	REF		0.039	REF	
С		0.508	BREF	0.020REF			
c1		0.508	BREF		0.020	REF	
D	6.550		6.650	0.258		0.262	
D1	5.10	00	5.460	0.201		0.215	
E	0.950		1.050	0.037		0.041	
E1	9.70	00	10.400	0.382		0.409	
E2	6.0	00	6.200	0.236 0.24		0.24	14
е		2.286	BSC		0.090	BSC	
e1	4.572REF			0.180REF			
L	2.6	50	2.950	0.104		0.11	6
L1	0.70	00	0.900	0.028		0.03	35
θ1	7°REF		7°REF				
R		1.300REF			0.051REF		
R1		0.250REF			0.010REF		



16mΩ, 60V, N-Channel Power MOSFET

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